

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Confirmation No.: 7113

Yuichi INADA, *et al.*

Art Unit: 1791

Application No.: 10/534,488

Examiner: Dimple N. BODAWALA

Filed: May 11, 2005

Attorney Dkt. No.: 059559.00020

For: MOLD FOR MOLDING, MOLDING METHOD, DISC SUBSTRATE, AND
MOLDING MACHINE

RESPONSE UNDER 37 C.F.R. §1.116

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450
MAIL STOP AF

January 16, 2009

Sir:

In response to the Office Action dated September 19, 2008, having been duly extended from December 19, 2008, until January 19, 2009, by the attached Petition for Extension of Time, please amend the above-identified application as set forth below.

Amendments to the claims are submitted beginning on page 2.

Remarks are submitted beginning on page 7.

DO NOT ENTER: /DB/